

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6020AL uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

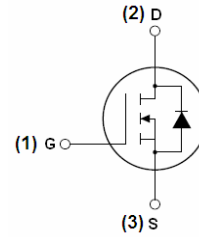
- $V_{DS} = 60V, I_D = 20A$
 $R_{DS(ON)} < 35m\Omega @ V_{GS} = 10V$
 $R_{DS(ON)} < 40m\Omega @ V_{GS} = 4.5V$
- High density cell design for ultra low R_{dson}
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

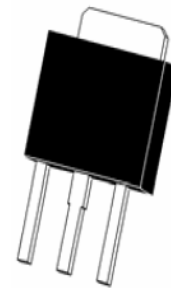
100% ΔV_{ds} TESTED!



Schematic diagram



Marking and pin assignment



TO-251S top view

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| NCE6020AL | NCE6020AL | TO-251S | - | - | - |

Absolute Maximum Ratings ($T_C = 25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|---|--------------------|------------|---------------|
| Drain-Source Voltage | V_{DS} | 60 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous | I_D | 20 | A |
| Drain Current-Continuous($T_C = 100^\circ C$) | $I_D(100^\circ C)$ | 14 | A |
| Pulsed Drain Current | I_{DM} | 60 | A |
| Maximum Power Dissipation | P_D | 45 | W |
| Derating factor | | 0.3 | W/ $^\circ C$ |
| Single pulse avalanche energy ^(Note 5) | E_{AS} | 72 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 175 | $^\circ C$ |

Thermal Characteristic

| | | | |
|--|-----------------|-----|------|
| Thermal Resistance, Junction-to-Case ^(Note 2) | $R_{\theta JC}$ | 3.3 | °C/W |
|--|-----------------|-----|------|

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|--------------|---|-----|------|-----------|------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 60 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=60V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 1.2 | 1.6 | 2.5 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=20A$ | - | 24 | 35 | m Ω |
| | | $V_{GS}=4.5V, I_D=20A$ | | 30 | 40 | |
| Forward Transconductance | g_{FS} | $V_{DS}=5V, I_D=5A$ | 11 | - | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=30V, V_{GS}=0V,$ $F=1.0\text{MHz}$ | - | 500 | - | PF |
| Output Capacitance | C_{oss} | | - | 60 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 25 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=30V, I_D=2A, R_L=6.7\Omega$ $V_{GS}=10V, R_G=3\Omega$ | - | 5 | - | nS |
| Turn-on Rise Time | t_r | | - | 2.6 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 16.1 | - | nS |
| Turn-Off Fall Time | t_f | | - | 2.3 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=30V, I_D=4.5A,$ $V_{GS}=10V$ | - | 25 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 4.5 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 6.5 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $V_{GS}=0V, I_S=20A$ | - | - | 1.2 | V |
| Diode Forward Current ^(Note 2) | I_S | | - | - | 20 | A |
| Reverse Recovery Time | t_{rr} | $T_J = 25^\circ\text{C}, I_F = 20A$ $di/dt = 100A/\mu s$ ^(Note 3) | - | 29 | - | nS |
| Reverse Recovery Charge | Q_{rr} | | - | 49 | - | nC |
| Forward Turn-On Time | t_{on} | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. EAS condition: $T_J=25^\circ\text{C}, V_{DD}=30V, V_G=10V, L=0.5\text{mH}, R_g=25\Omega$

Test Circuit

1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

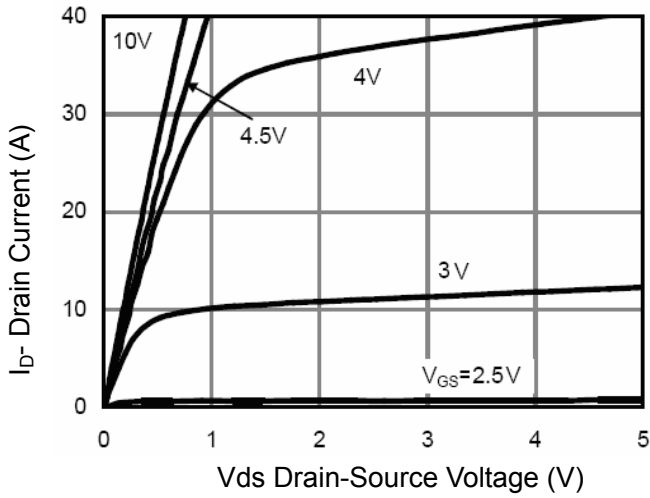


Figure 1 Output Characteristics

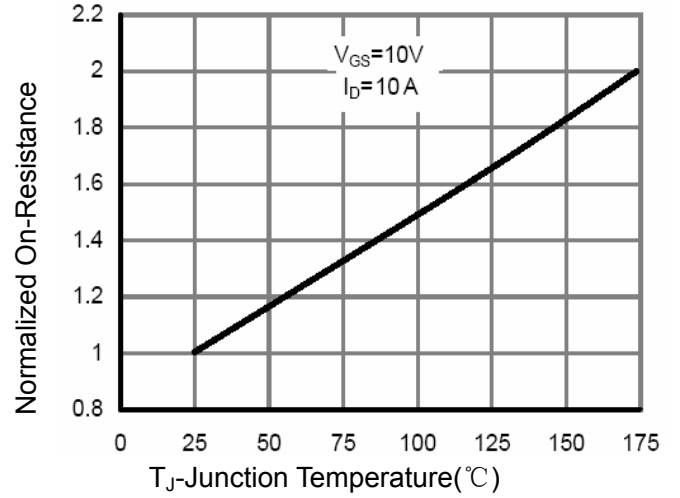


Figure 4 R_{dson} -Junction Temperature

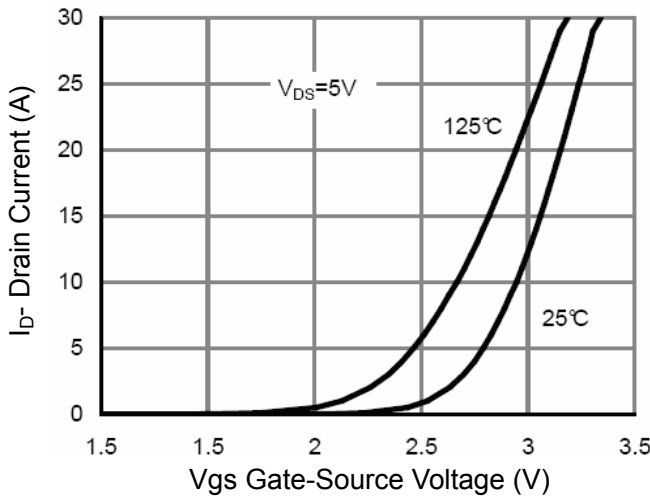


Figure 2 Transfer Characteristics

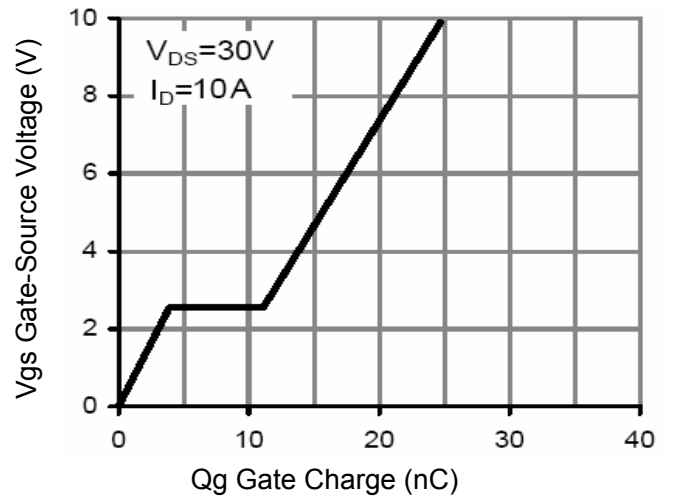


Figure 5 Gate Charge

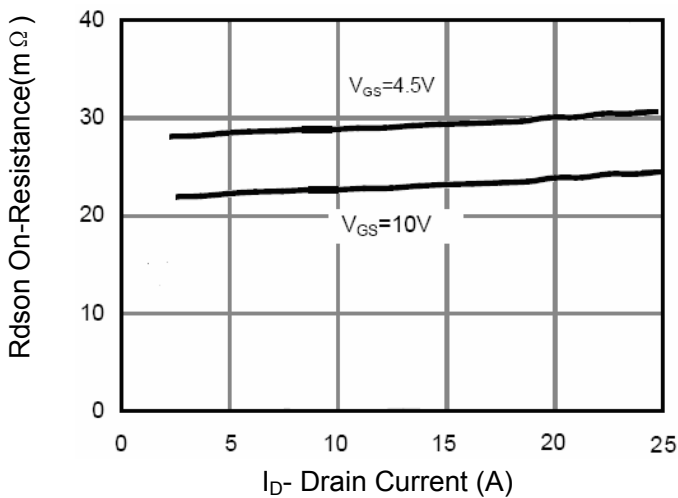


Figure 3 R_{dson} - Drain Current

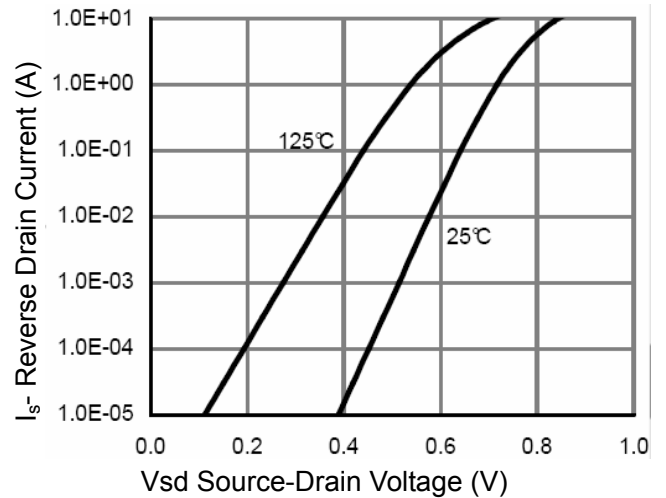


Figure 6 Source- Drain Diode Forward

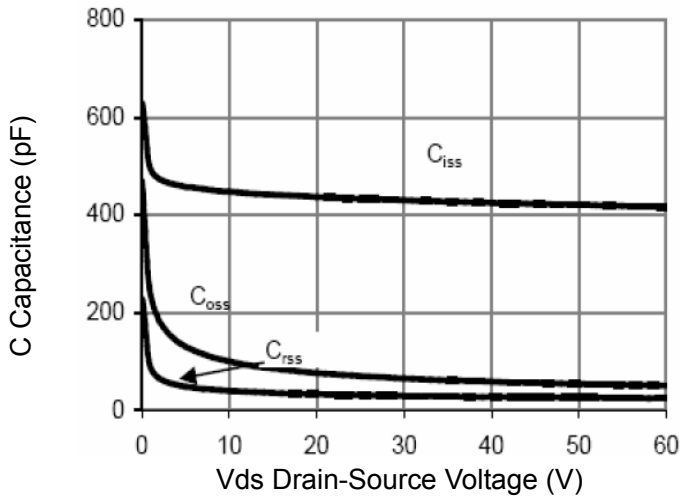


Figure 7 Capacitance vs Vds

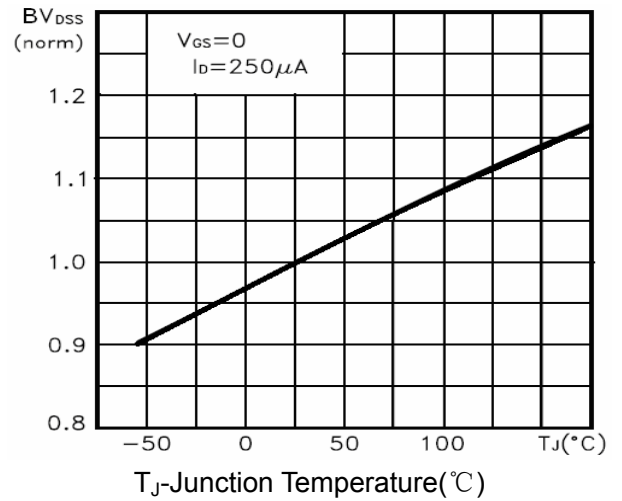


Figure 9 BV_{DSS} vs Junction Temperature

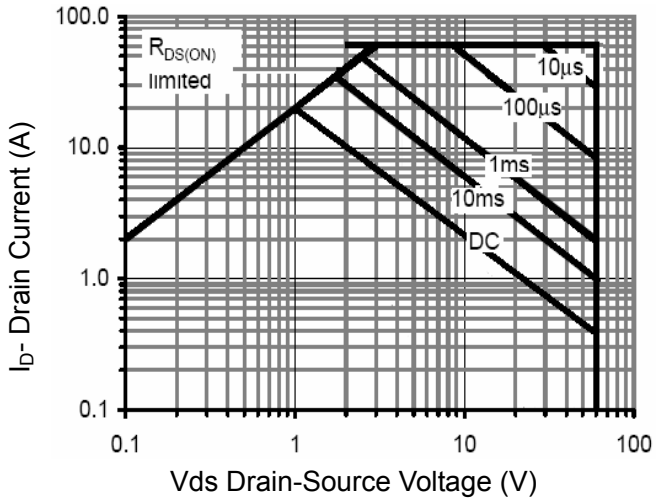


Figure 8 Safe Operation Area

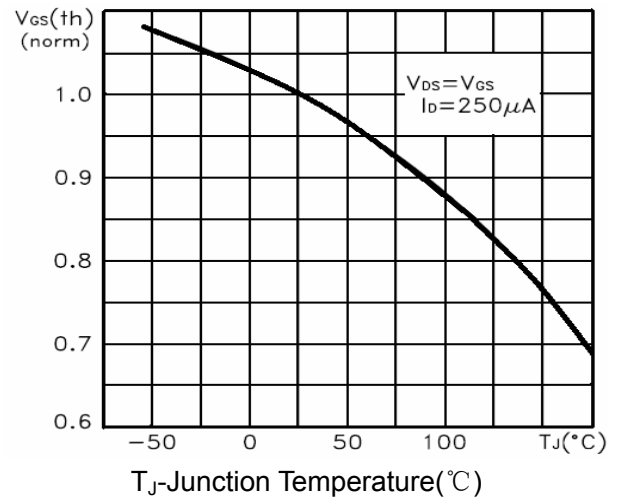


Figure 10 $V_{GS(th)}$ vs Junction Temperature

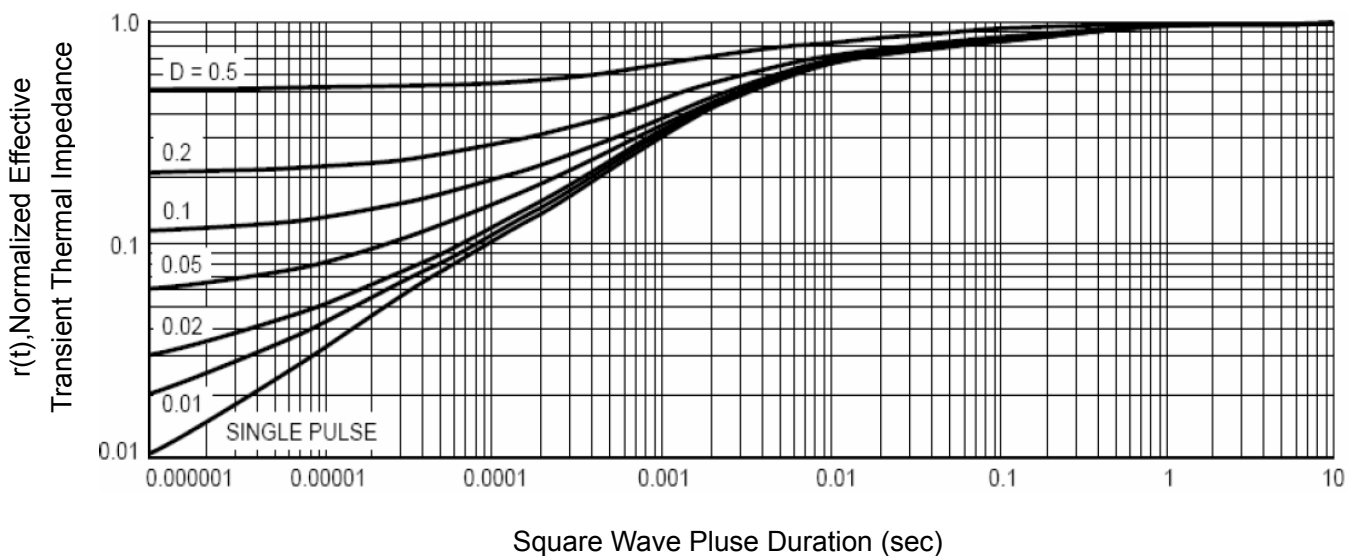
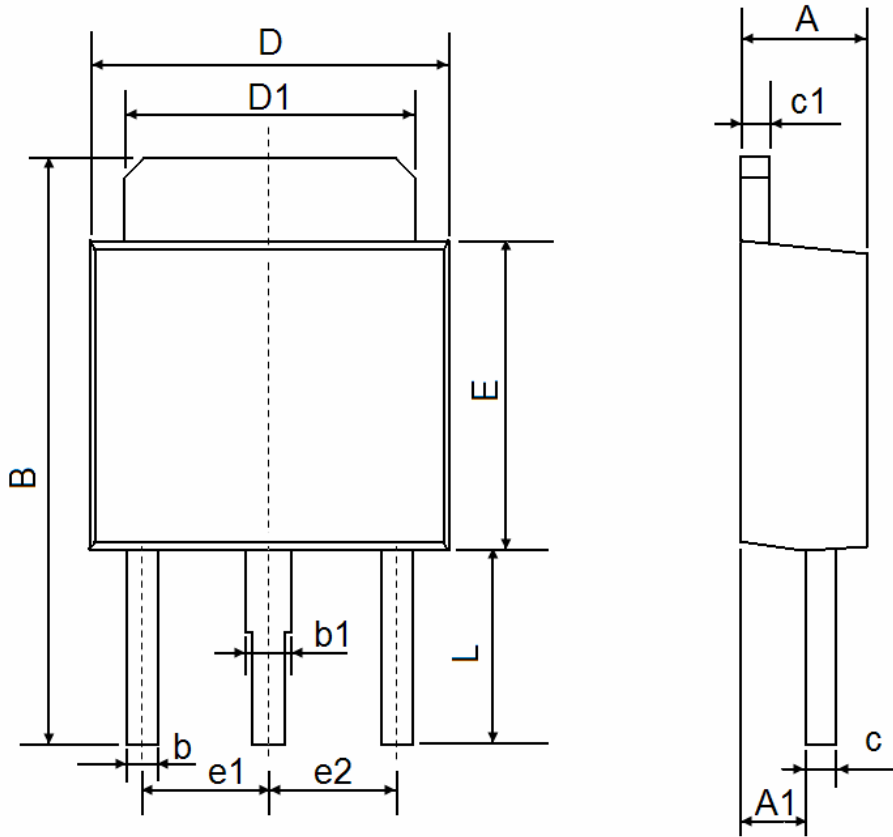


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-251S Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.250 | 2.350 | 0.089 | 0.093 |
| A1 | 1.150 | 1.250 | 0.045 | 0.049 |
| B | 10.200 | 10.800 | 0.402 | 0.425 |
| b | 0.550 | 0.650 | 0.022 | 0.026 |
| b1 | 0.750 | 0.850 | 0.030 | 0.033 |
| c | 0.480 | 0.540 | 0.019 | 0.021 |
| c1 | 0.480 | 0.540 | 0.019 | 0.021 |
| D | 6.400 | 6.600 | 0.252 | 0.260 |
| D1 | 5.250 | 5.350 | 0.207 | 0.211 |
| E | 5.400 | 5.600 | 0.213 | 0.220 |
| e1 | 2.300 TYP | | 0.091 TYP | |
| e2 | 2.300 TYP | | 0.091 TYP | |
| L | 3.300 | 3.700 | 0.130 | 0.146 |

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